RGWX5TS65EHR

650V 75A Field Stop Trench IGBT

Datasheet

V _{CES}	650V
I _{C (100°C)}	75A
V _{CE(sat) (Typ.)}	1.5V
P_{D}	348W

Outline TO-247N (1) (2)(3)

Features

- 1) AEC-Q101 Qualified
- 2) Low Collector Emitter Saturation Voltage
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD
- 5) Pb free Lead Plating; RoHS Compliant

Application

Automotive

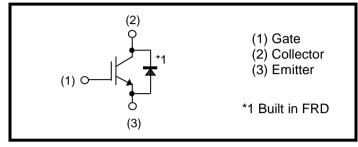
On & Off Board Chargers

DC-DC Converters

PFC

Industrial Inverter

●Inner Circuit



Packaging Specifications

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	Packaging	Tube			
	Reel Size (mm)	-			
Type	Tape Width (mm)	-			
Type Basic Ordering Unit (pcs) Packing Code Marking	450				
	Packing Code	C11			
	Marking	RGWX5TS65E			

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter	Parameter		Value	Unit
Collector - Emitter Voltage		V_{CES}	650	V
Gate - Emitter Voltage		V_{GES}	±30	V
Collector Current	T _C = 25°C	I _C	132	А
Collector Current	T _C = 100°C	I _C	81	А
Pulsed Collector Current		I _{CP} *1	300	А
Diodo Forward Current	T _C = 25°C	I _F	127	А
Diode Forward Current	T _C = 100°C	I _F	80	А
Diode Pulsed Forward Current	Diode Pulsed Forward Current		300	А
Power Dissipation	T _C = 25°C	P_{D}	348	W
	T _C = 100°C	P _D	174	W
Operating Junction Temperature		T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C

^{*1} Pulse width limited by T_{imax.}

●Thermal Resistance

Parameter	Symbol	Values			Unit
Falametei	Symbol	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.43	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	ı	0.57	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
r arameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	650	ı	ı	V
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	ı	ı	10	μА
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	ı	ı	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 50.4 \text{mA}$	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_{C} = 75A, V_{GE} = 15V,$ $T_{j} = 25^{\circ}C$ $T_{j} = 175^{\circ}C$		1.5 1.85	1.9 -	V

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

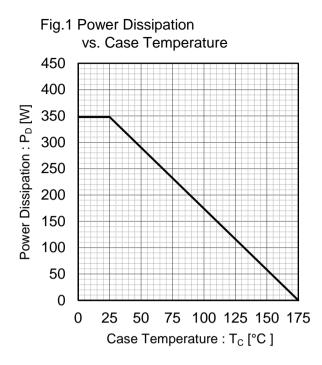
Doromator	Symbol	Conditions	Values			l limit
Parameter			Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	$V_{CE} = 30V$,	-	5980	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$,	-	156	-	pF
Reverse transfer Capacitance	C _{res}	f = 1MHz	-	118	-	
Total Gate Charge	Q_g	V _{CE} = 400V,	-	213	-	
Gate - Emitter Charge	Q_ge	I _C = 75A,	-	42	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	82	-	
Turn - on Delay Time	t _{d(on)}		-	59	-	
Rise Time	t _r	$I_C = 37.5A, V_{CC} = 400V, V_{GF} = 15V, R_G = 10\Omega,$	-	18	-	ns
Turn - off Delay Time	t _{d(off)}	$T_i = 25^{\circ}C$	-	243	-	
Fall Time	t _f	Inductive Load *E _{on} include diode reverse recovery	-	35	-	
Turn - on Switching Loss	E _{on}		-	0.99	-	m l
Turn - off Switching Loss	E _{off}		-	0.73	-	mJ
Turn - on Delay Time	t _{d(on)}		-	55	-	
Rise Time	t _r	$I_C = 37.5A, V_{CC} = 400V,$ $V_{GE} = 15V, R_G = 10\Omega,$	-	18	-	ns
Turn - off Delay Time	t _{d(off)}	$T_i = 175^{\circ}C$	-	278	-	
Fall Time	t _f	Inductive Load	-	76	-	
Turn - on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	0.95	-	m l
Turn - off Switching Loss	E_{off}		-	0.99	-	mJ
Reverse Bias Safe Operating Area		I _C = 300A, V _{CC} = 520V,				
	RBSOA	$V_P = 650V, V_{GE} = 15V,$ $R_G = 100\Omega, T_j = 175^{\circ}C$	FULL SQUARE		-	

•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Cumbal	Conditions	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Offic
		I _F = 75A,				
Diode Forward Voltage	V_{F}	T _j = 25°C	-	1.45	1.9	V
		T _j = 175°C	-	1.55	-	
Diode Reverse Recovery Time	t _{rr}		-	100	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	$I_F = 37.5A,$ $V_{CC} = 400V,$	-	11.5	1	А
Diode Reverse Recovery Charge	Q _{rr}	di _F /dt = 200A/µs, T _j = 25°C	-	0.64	1	μC
Diode Reverse Recovery Energy	Err		-	26.0	-	μJ
Diode Reverse Recovery Time	t _{rr}	$I_F = 37.5A,$ $V_{CC} = 400V,$ $di_F/dt = 200A/\mu s,$ $T_j = 175^{\circ}C$	-	194	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	16.7	-	А
Diode Reverse Recovery Charge	Q _{rr}		_	1.93	-	μC
Diode Reverse Recovery Energy	E _{rr}		-	113	-	μJ

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• Electrical Characteristic Curves



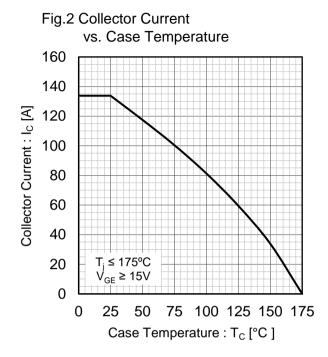


Fig.3 Forward Bias Safe Operating Area

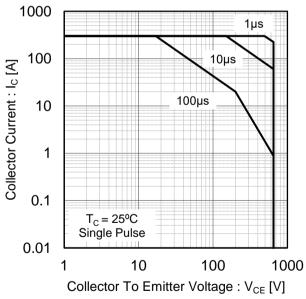
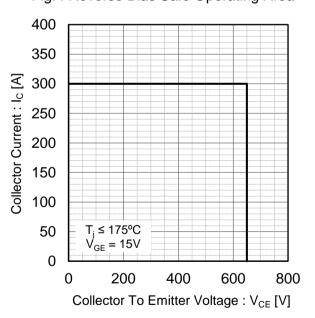


Fig.4 Reverse Bias Safe Operating Area



•Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

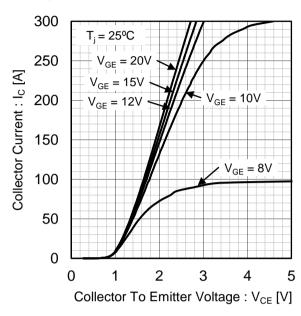


Fig.6 Typical Output Characteristics

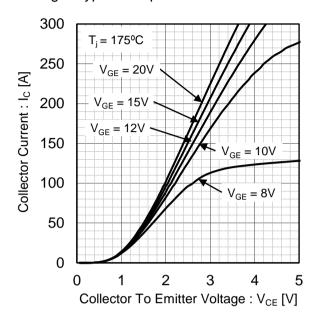


Fig.7 Typical Transfer Characteristics

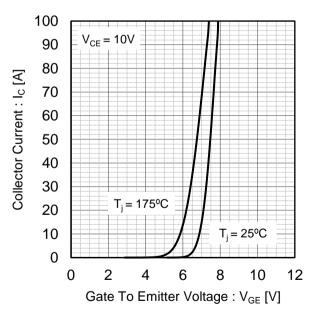
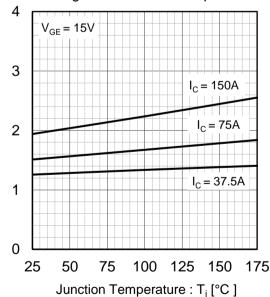


Fig.8 Typical Collector to Emitter Saturation Voltage vs. Junction Temperature



Collector To Emitter Saturation

Voltage: V_{CE(sat)} [V]

● Electrical Characteristic Curves

Voltage vs. Gate to Emitter Voltage 20 $T_i = 25^{\circ}C$ Collector To Emitter Saturation $I_{\rm C} = 150A$ 15 $I_C = 75A$ Voltage: V_{CE(sat)} [V] $I_{\rm C} = 37.5 {\rm A}$ 10 5 0 5 10 15 20

Fig.9 Typical Collector to Emitter Saturation

Gate To Emitter Voltage: V_{GE} [V]

Fig.10 Typical Collector to Emitter Saturation Voltage vs. Gate to Emitter Voltage

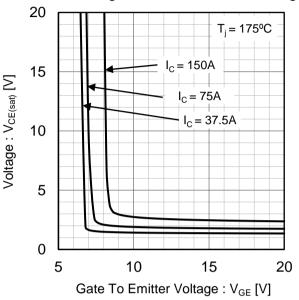
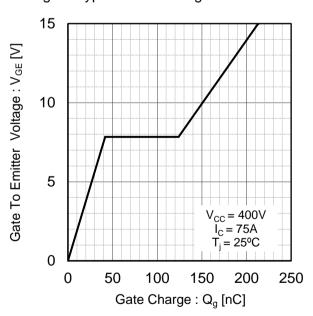


Fig.11 Typical Capacitance vs. Collector to Emitter Voltage 100000 C_{ies} 10000 Capacitance [pF] 1000 Coes 100 C_{res} 10 f = 1MHz $V_{GE} = 0V$ = 25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage: V_{CE} [V]

Fig.12 Typical Gate Charge



Collector To Emitter Saturation

ROHM

• Electrical Characteristic Curves

Fig.13 Typical Switching Time vs. Collector Current

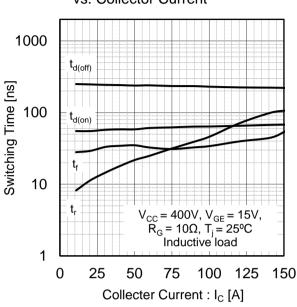


Fig.14 Typical Switching Time vs. Gate Resistance

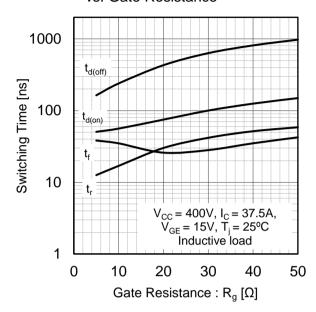


Fig.15 Typical Switching Energy Losses vs. Collector Current

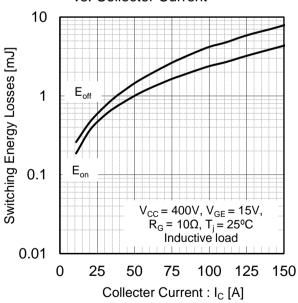
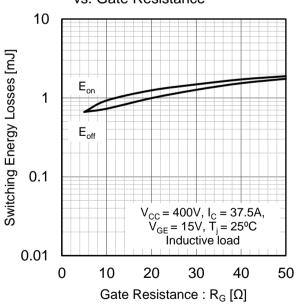


Fig.16 Typical Switching Energy Losses vs. Gate Resistance



• Electrical Characteristic Curves

Fig.17 Typical Switching Time vs. Collector Current

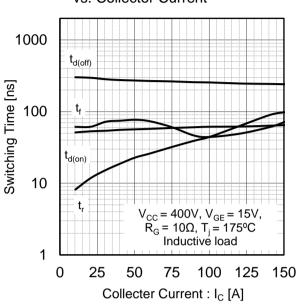


Fig.18 Typical Switching Time vs. Gate Resistance

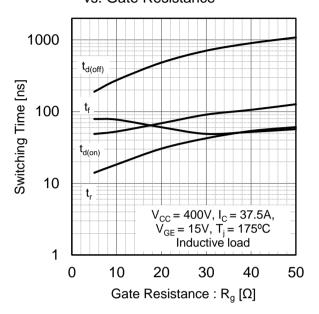


Fig.19 Typical Switching Energy Losses vs. Collector Current

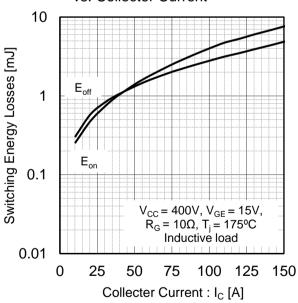
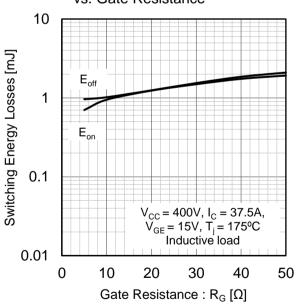


Fig.20 Typical Switching Energy Losses vs. Gate Resistance



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● Electrical Characteristic Curves

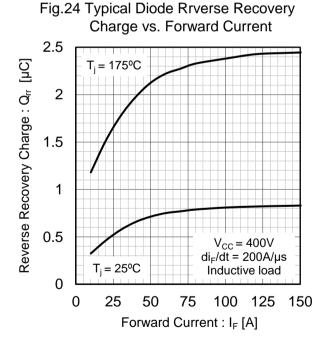
Fig.21 Typical Diode Forward Current vs. Forward Voltage 300 250 Forward Current : I_F [A] 200 150 100 $T_i = 25^{\circ}C$ $T_i = 175^{\circ}C$ 50 0 0.5 1 1.5 2 2.5 3 0 Forward Voltage: V_F [V]

vs. Forward Current 400 Reverse Recovery Time: t_{rr} [ns] 300 $T_i = 175^{\circ}C$ 200 100 $V_{CC} = 400V$ di_F/dt = 200A/µs $T_i = 25^{\circ}C$ Inductive load 0 25 50 75 100 125 150 0

Forward Current : I_F [A]

Fig.22 Typical Diode Revese Recovery Time

Fig.23 Typical Diode Reverse Recovery Current vs. Forward Current 20 $T_i = 175^{\circ}C$ Reverse Recovery Current : In [A] 15 10 5 $T_i = 25^{\circ}C$ $V_{CC} = 400V$ di_F/dt = 200A/µs Inductive load 0 25 0 50 75 100 125 150 Forward Current : I_F [A]



•Electrical Characteristic Curves

Fig.25 Typical IGBT Transient Thermal Impedance

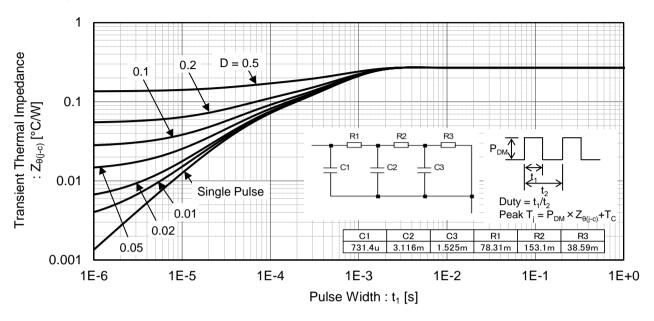
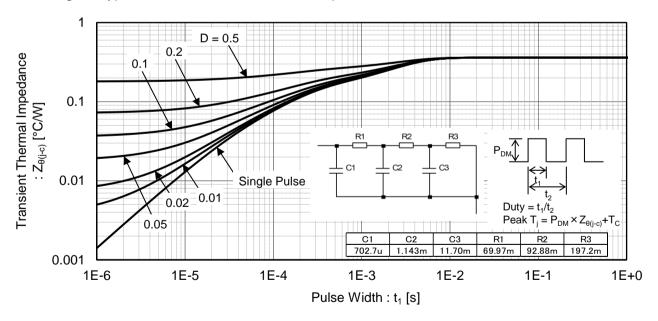


Fig.26 Typical Diode Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

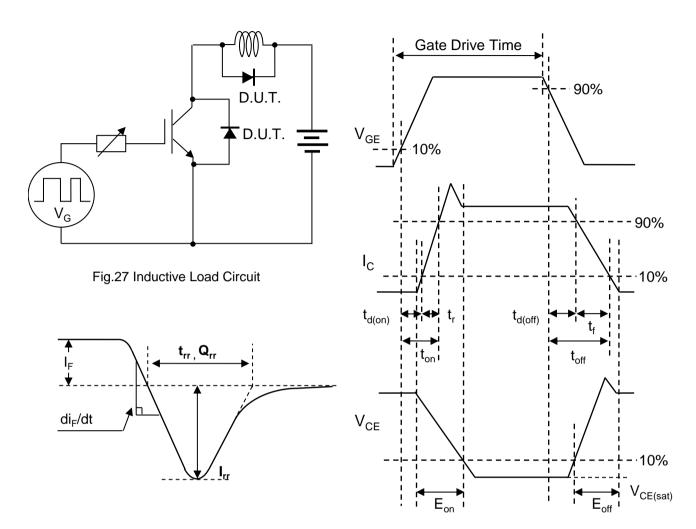


Fig.29 Diode Reverse Recovery Waveform

Fig.28 Inductive Load Waveform

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